# Onsemi

# **MOSFET** - Power, Single N-Channel, STD Gate, SO8FL

# 80 V, 2.55 mΩ, 156 A NVMFWS2D5N08X

### Features

- Low Q<sub>RR</sub>, Soft Recovery Body Diode
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

## Applications

- Synchronous Rectification (SR) in DC-DC and AC-DC
- Primary Switch in Isolated DC-DC Converter
- Motor Drives
- Automotive 48 V System

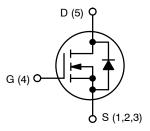
## MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise stated)

Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage	V <sub>DSS</sub>	80	V	
Gate-to-Source Voltage	Gate-to-Source Voltage			V
Continuous Drain Current	ain Current $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$		156	А
(Note 1)			110	
Power Dissipation (Note 1)	T <sub>C</sub> = 25°C	PD	133	W
Pulsed Drain Current	$T_{\rm C} = 25^{\circ}{\rm C},$	I <sub>DM</sub>	640	А
Pulsed Source Current (Body Diode)	t <sub>p</sub> = 100 μs	I <sub>SM</sub>	640	
Operating Junction and Storage Range	T <sub>J</sub> , T <sub>STG</sub>	–55 to +175	°C	
Source Current (Body Diode)	۱ <sub>S</sub>	201	А	
Single Pulse Avalanche Energy (I <sub>PK</sub> = 53 A) (Note 3)	E <sub>AS</sub>	140	mJ	
Lead Temperature for Soldering (1/8" from case for 10 s)	ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- Surface-mounted on FR4 board using 1 in<sup>2</sup>, 1 oz. Cu pad.
  The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 3.  $E_{AS}$  of 140 mJ is based on started  $T_J$  = 25°C,  $I_{AS}$  = 53 A,  $V_{DD}$  = 64 V, V<sub>GS</sub> = 10 V, 100% avalanche tested.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
80 V	$2.55~\mathrm{m}\Omega$ @ 10 V	156 A	



**N-CHANNEL MOSFET** 



DFNW5 (SO-8FL) CASE 507BA



2D5N8W = Specific Device Code

- А = Assembly Location
- Υ = Year
- W = Work Week
- ΖZ = Assembly Lot Code

# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NVMFWS2D5N08XT1G	DFNW5	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### **THERMAL CHARACTERISTICS**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.12	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	39	

Surface-mounted on FR4 board using 1 in<sup>2</sup>, 1 oz. Cu pad.
 R<sub>thJA</sub> is determined by the user's board design.

### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u>.</u>		_		_	_
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C	80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_{J}$	I <sub>D</sub> = 1 mA, Referenced to 25°C		31.6		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 80 \text{ V}, \text{ T}_{\text{J}} = 25^{\circ}\text{C}$			1	μΑ
		$V_{DS} = 80 \text{ V}, \text{ T}_{J} = 125^{\circ}\text{C}$			250	1
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = 10 V, $I_D$ = 37 A, $T_J$ = 25°C		2.2	2.55	mΩ
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS}=V_{DS},I_{D}=184\;\mu A,T_{J}=25^{\circ}C$	2.4		3.6	V
Gate Threshold Voltage Temperature Coefficient	${\Delta V_{GS(TH)} / \over \Delta T_J}$	$V_{GS}$ = $V_{DS}$ , $I_D$ = 184 $\mu$ A		-7.5		mV/°C
Forward Transconductance	<b>9</b> FS	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 37 \text{ A}$		115		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE					
Input Capacitance	C <sub>ISS</sub>			3200		pF
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 40 V, f = 1 MHz		930		-
Reverse Transfer Capacitance	C <sub>RSS</sub>			14		
Output Charge	Q <sub>OSS</sub>			66		nC
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 6 V, $V_{DD}$ = 40 V, $I_D$ = 37 A		28		
				45		]
Threshold Gate Charge	Q <sub>G(TH)</sub>	1		10		]
Gate-to-Source Charge	Q <sub>GS</sub>	$V_{GS}$ = 10 V, $V_{DD}$ = 40 V, $I_{D}$ = 37 A		15		1
		-4		-	-	1

Gate Resistance
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Gate-to-Drain Charge

Gate Plateau Voltage

#### SWITCHING CHARACTERISTICS

Turn-On Delay Time	t <sub>d(ON)</sub>		24	ns
Rise Time	t <sub>r</sub>	Resistive Load,	9	
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$V_{GS} = 0/10 \text{ V}, V_{DD} = 64 \text{ V}, I_D = 37 \text{ A}, R_G = 2.5 \Omega$	36	
Fall Time	t <sub>f</sub>		6	

f = 1 MHz

 $Q_{GD}$ 

 $V_{GP}$ 

 $\mathsf{R}_\mathsf{G}$ 

7

4.7

0.8

V

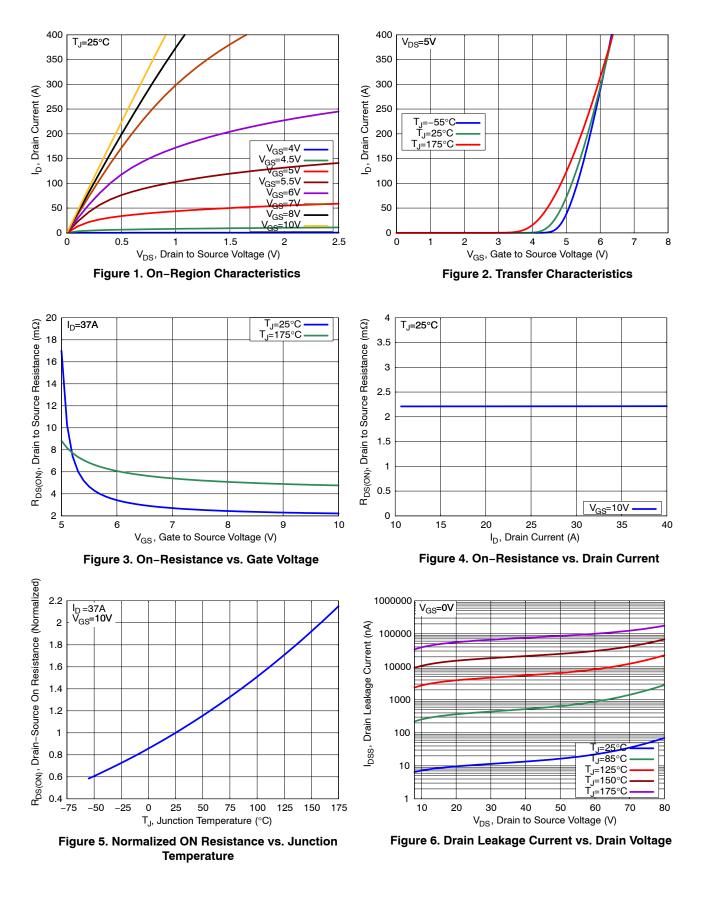
Ω

#### SOURCE-TO-DRAIN DIODE CHARACTERISTICS

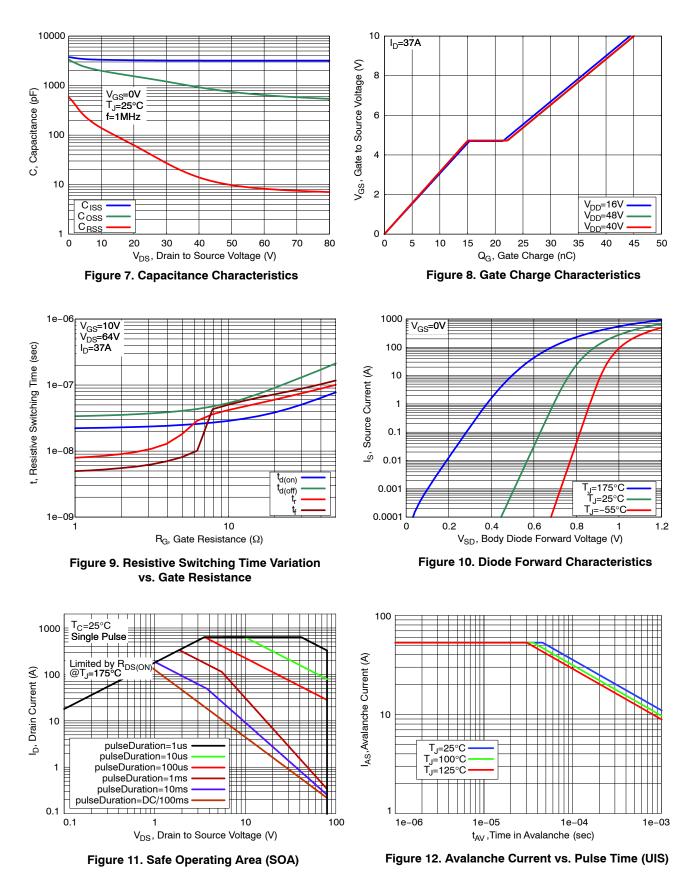
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS}$ = 0 V, $I_S$ = 37 A, $T_J$ = 25°C	0.82	1.2	V
		$V_{GS}$ = 0 V, $I_S$ = 37 A, $T_J$ = 125°C	0.66		
Reverse Recovery Time	t <sub>RR</sub>		24		ns
Charge Time	t <sub>a</sub>	V <sub>GS</sub> = 0 V, dI/dt = 1000 A/µs,	13		
Discharge Time	t <sub>b</sub>	$I_{\rm S} = 37$ A, $V_{\rm DD} = 64$ V	10		
Reverse Recovery Charge	Q <sub>RR</sub>		167		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **TYPICAL CHARACTERISTICS**



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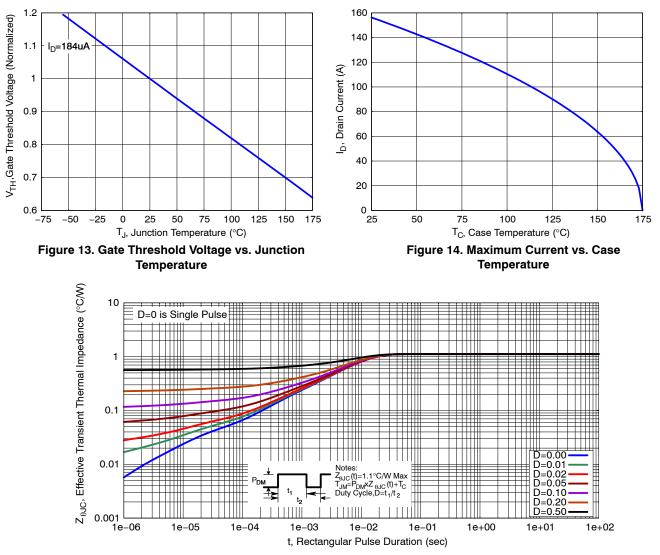
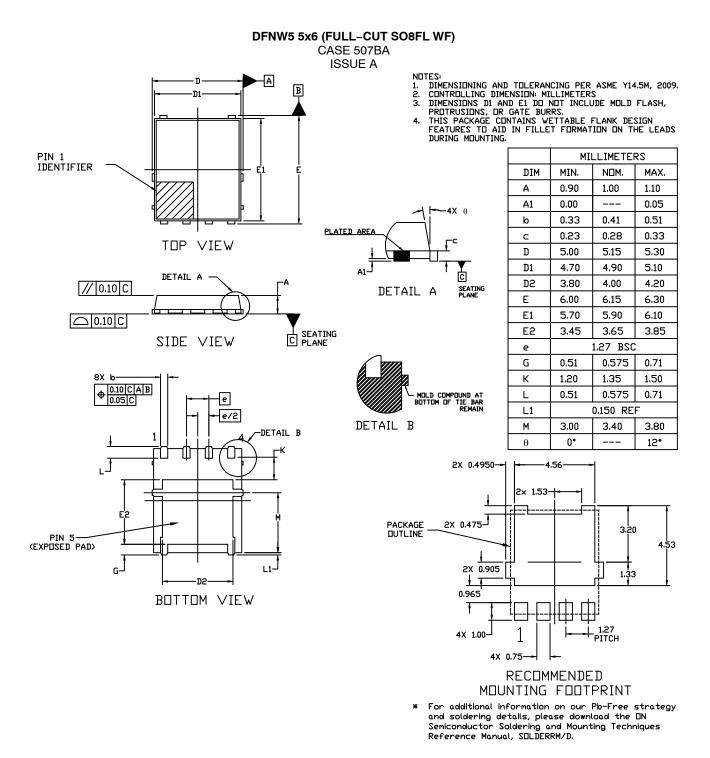


Figure 15. Transient Thermal Response

### PACKAGE DIMENSIONS



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